





February 2016



- Pletronics' LV99D Series is a quartz crystal controlled precision square wave generator with an LVDS output.
- The package is designed for high density surface mount designs.
- · Low cost mass produced oscillator.
- Tape and Reel or cut tape packaging is available.
- 5 x 7 mm LCC Ceramic Package
- Enable/Disable Function on pad 1
- Output frequency is synthesized.
- Low Jitter

Pletronics Inc. certifies this device is in accordance with the RoHS 6/6 (2011/65/EC) and WEEE (2002/96/EC) directives.

Pletronics Inc. guarantees the device does not contain the following: Cadmium, Hexavalent Chromium, Lead, Mercury, PBB's, PBDE's

Weight of the Device: 0.16 grams

Moisture Sensitivity Level: 1 As defined in J-STD-020C

Second Level Interconnect code: e4

Absolute Maximum Ratings:

Parameter	Unit						
V _{CC} Supply Voltage	-0.5V to +5.0V						
Vi Input Voltage	-0.5V to V _{CC} + 0.5V						
Vo Output Voltage	-0.5V to V _{CC} + 0.5V						

Thermal Characteristics

The maximum die or junction temperature is 155°C

The thermal resistance junction to board is 30 to 50°C/Watt depending on the solder pads, ground plane and construction of the PCB.



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Part Number:

LV99	45	D	Ε	٧	-375.0M	-XX	
							Packaging code or blank T250 = 250 per Tape and Reel T500 = 500 per Tape and Reel T1K = 1000 per Tape and Reel
							Frequency in MHz
							Supply Voltage V _{CC} V = 3.3V <u>+</u> 10%
							Temperature Range blank = -10 to +70°C C = -40 to +70°C E = -40 to +85°C
							Series Model
							Frequency Stability 45 = ± 50 ppm 44 = ± 25 ppm 20 = ± 20 ppm
							Series Model

Part Marking:

PLE LV99 Marking Legend:

FF.FFF M PLE = Pletronics

• YMDXX FF.FFF M = Frequency in MHZ

YMD = Date of Manufacture (year-month-day)
All other marking is internal factory codes

Codes for Date Code YMD

Code	4	5	6	7	8	Code	Α	В	С	D	E	F	G	Н	J	K	L	M
Year	2014	2015	2016	2017	2018	Month	JAN	FEB	MAR	APR	MAY	JUN	JUL	AUG	SEP	OCT	NOV	DEC

Code	1	2	3	4	5	6	7	8	9	Α	В	С	D	Е	F	G
Day	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16
Code	Н	J	K	L	M	N	Р	R	Т	U	٧	W	X	Υ	Z	
Day	17	18	19	20	21	22	23	24	25	26	27	28	29	30	31	



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Electrical Specification for 3.30V $\pm 10\%$ over the specified temperature range and the frequency range of 10.9 MHz to 670 MHz

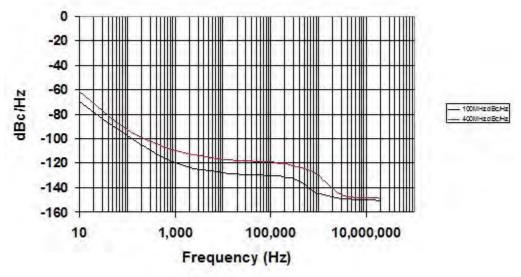
Item	Min	Max	Unit	Condition
Frequency Accuracy "45"	-50	+50	ppm	For all supply voltages, load changes, aging for 1
"44"	-25	+25		year, shock, vibration and temperatures
"20"	-20	+20		
Output Waveform		LVDS		
Output High Level		1.60	Volts	
Output Low Level	0.90		Volts	See load circuit
Differential Output (V _{OD})	250	450	mVolts	D4 50 skm-
Output Offset Voltage (Vos)	1.125	1.375	Volts	R1 = 50 ohms
Differential Output Error (dVos)		50	mVolts	
Output Symmetry	47	53	%	Referenced to 50% of amplitude or crossing point
Output T _{RISE} and T _{FALL}	150	230	pS	Vth is 20% and 80% of waveform
Jitter	-	0.6	pS RMS	Measured from 12KHz to 20MHz from Fnominal
	-	2.8		Measured from 10Hz to 20MHz from Fnominal
Output Short Circuit Current	-	-20	mA	Vout = 0.0V
Vcc Supply Current	-	80	mA	
Enable/Disable Internal Pull-up	50	-	Kohm	To Vcc (equivalent resistance)
V disable	-	0.8	Volts	Referenced to Ground
V enable	2.0	-	Volts	Referenced to Ground
Output leakage V _{OUT} = V _{CC}	-20	+20	uA	Pad 1 low, device disabled
$V_{OUT} = 0V$	-20	+20	uA	
Enable	-	10	nS	Time for output to reach a logic state
Disable time	-	10	nS	Time for output to reach a high Z state
Start up time	-	5	mS	Measured from the time Vcc = 3.0V
Operating Temperature Range	-10	+70	°C	Standard Temperature Range
	-20	+70	°C	Extended Temperature Range "C" Option
	-40	+85	°C	Extended Temperature Range "E" Option
Storage Temperature Range	-55	+125	°C	

Specifications with Pad 1 E/D open circuit

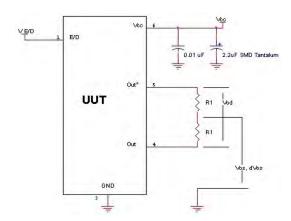


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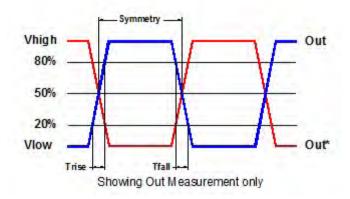
Typical Phase-Noise Response



Load Circuit



Test Waveform





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Reliability: Environmental Compliance

Parameter	Condition
Mechanical Shock	MIL-STD-883 Method 2002, Condition B
Vibration	MIL-STD-883 Method 2007, Condition A
Solderability	MIL-STD-883 Method 2003
Thermal Shock	MIL-STD-883 Method 1011, Condition A

ESD Rating

Model	Minimum Voltage	Conditions
Human Body Model	2000	MIL-STD-883 Method 3115
Charged Device Model	1500	JESD 22-C101

Package Labeling

Label is 1" x 2.6" (25.4mm x 66.7mm) Font is Courier New Bar code is 39-Full ASCII

LV9920DV-312.50M

Customer P/N:

D/C

Label is 1" x 2.6" (25.4mm x 66.7mm) Font is Arial

RoHS Compliant

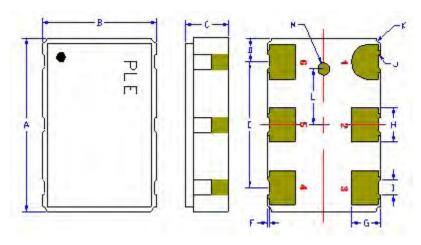
2nd LvL Interconnect Category=e4

Max Safe Temp=260C for 10s 2X Max



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Mechanical:



Contacts:

Gold 11.8 to 39.4 $\mu inches$ (0.3 to 1.0 $\mu m)$ over

Nickel 50 to 350 μ inches (1.27 to 8.89 μ m)

Center metalized pad "M" on the base is not internally connected.

¹ Typical dimensions

Not to Scale

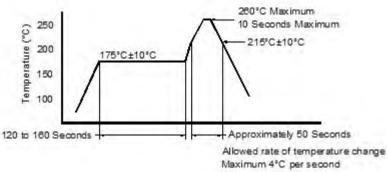
	Inches	mm
Α	0.276 <u>+</u> 0.006	7.00 <u>+</u> 0.15
В	0.197 <u>+</u> 0.006	5.00 <u>+</u> 0.15
O	0.067 max	1.70 max
D¹	0.038	0.96
E¹	0.200	5.08
F¹	0.004	0.10
G¹	0.050	1.27
H¹	0.055	1.40
l¹	0.024	0.60
J¹	0.004r	0.10r
K¹	0.008r	0.20r
L ¹	0.089	2.25
M¹	0.010r	0.25r

Pad	Function	Note
1	Output Enable/Disable	When this pad is not connected the oscillator shall operate. If <0.80 volts, the output will be inhibited (high impedance state.) Recommend connecting this pad to $V_{\rm cc}$ if the oscillator is to be always on.
2	No connect	This pad should be connected to Ground or Supply Voltage to lower the packages thermal resistance.
3	Ground (GND)	
4	Output	The outputs must be terminated, 100 ohms between the outputs is the ideal
5	Output*	termination. Capacitor coupled terminations can be used.
6	Supply Voltage (V _{cc})	Recommend connecting appropriate power supply bypass capacitors as close as possible.



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Reflow Cycle (typical for lead free processing)



The part may be reflowed 3 times without degradation.

Tape and Reel: available for quantities of 250 to 1000 per reel, cut tape for < 250

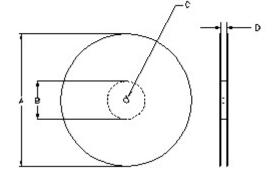
	Constant Dimensions Table 1										
Tape Size	D0	D1 Min	E1	P0	P2	S1 Min	T Max	T1 Max			
8mm		1.0			2.0						
12mm	1.5	1.5	1.75	4.0	<u>+</u> 0.05						
16mm	+0.1 -0.0	1.5	<u>+</u> 0.1	<u>+</u> 0.1	2.0	0.6	0.6	0.1			
24mm		1.5			<u>+</u> 0.1						

Variable Dimensions Table 2									
Tape Size	B1 Max	E2 Min	F	P1	T2 Max	W Max	Ao, Bo & Ko		
16 mm	12.1	14.25	7.5 <u>+</u> 0.1	8.0 <u>+</u> 0.1	8.0	16.3	Note 1		

Note 1: Embossed cavity to conform to EIA-481-B

Dimensions in mm

Not to scale



# #	CGM F 1 APR	10 PITCHES CUMULATIVE TOLERANCE ON TAPE +/- 0.2 mm P2 P0 A0 P1 WPERN WPERN P1 WPERN P2 P1 WPERN P2 P0 P1 WPERN P1 WPERN P1 WPERN P1 WPERN P1 WPERN WPERN P1 WPERN WPERN WPERN P1 WPERN WPER	E1 WE2 F
		EE MITH	r≢ cµn∿ sat

USER DIRECTION OF UNREELING -

	REEL DIMENSIONS				
Α	inches	7.0	10.0	13.0	
	mm	177.8	254.0	330.2	
В	inches	2.50	4.00	3.75	
	mm	63.5	101.6	95.3	Tape Width
С	mm	13.0 +0.5 / -0.2			vviatn
D	mm	16.4 +2.0 -0.0	16.4 +2.0 -0.0	16.4 +2.0 -0.0	16.0

Reel dimensions may vary from the above